## Octal 3-State Noninverting Buffer/Line Driver/ Line Receiver with LSTTL-Compatible Inputs

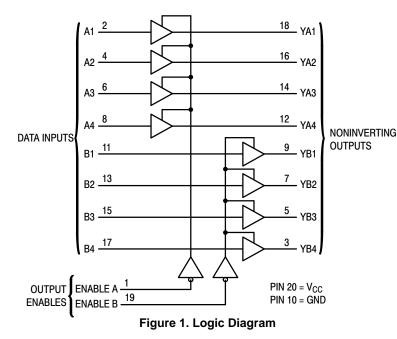
## High–Performance Silicon–Gate CMOS

The MC74HCT244A is identical in pinout to the LS244. This device may be used as a level converter for interfacing TTL or NMOS outputs to High–Speed CMOS inputs. The HCT244A is an octal noninverting buffer line driver line receiver designed to be used with 3–state memory address drivers, clock drivers, and other bus–oriented systems. The device has non–inverted outputs and two active–low output enables.

The HCT244A is the non-inverting version of the HCT240. See also HCT241.

#### Features

- Output Drive Capability: 15 LSTTL Loads
- TTL NMOS-Compatible Input Levels
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 4.5 to 5.5 V
- Low Input Current: 1 µA
- In Compliance with the Requirements Defined by JEDEC Standard No. 7 A
- Chip Complexity: 112 FETs or 28 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant





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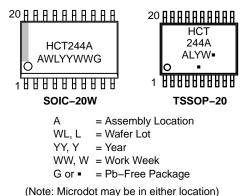
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#### PIN ASSIGNMENT

			_
ENABLE A	1•	20	⊒ V <sub>CC</sub>
A1 🛙	2	19	ENABLE B
YB4 [	3	18	D YA1
A2 [	4	17	] B4
үвз С	5	16	] YA2
A3 [	6	15	🛛 ВЗ
YB2	7	14	] YA3
A4 [	8	13	] B2
YB1 C	9	12	D YA4
GND [	10	11	] B1







Inpu	Outputs	
Enable A, Enable B A, E		YA, YB
L	L	L
L	н	н
Н	Х	Z

Z = high impedance, X = don't care

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 5 of this data sheet.

#### MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage (Referenced to GND)	-0.5 to +7	V
V <sub>in</sub>	DC Input Voltage (Referenced to GND)	–0.5 to V <sub>CC</sub> + 0.5	V
V <sub>out</sub>	DC Output Voltage (Referenced to GND)	–0.5 to V <sub>CC</sub> + 0.5	V
l <sub>in</sub>	DC Input Current, per Pin	±20	mA
l <sub>out</sub>	DC Output Current, per Pin	±35	mA
I <sub>CC</sub>	DC Supply Current, $V_{CC}$ and GND Pins	±75	mA
PD	Power Dissipation in Still Air, SOIC Package† TSSOP Package†	500 450	mW
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 Seconds (SOIC or TSSOP Package)	260	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range GND  $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ .

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

†Derating: SOIC Package: -7 mW/°C from 65° to 125°C

TSSOP Package: -6.1 mW/°C from 65° to 125°C

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter		Max	Unit
V <sub>CC</sub>	DC Supply Voltage (Referenced to GND)	4.5	5.5	V
V <sub>in</sub> , V <sub>out</sub>	DC Input Voltage, Output Voltage (Referenced to GND)	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature, All Package Types	-55	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time (Figure 2)	0	500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

				Guaranteed Limit			
Symbol	Parameter	Test Conditions	V <sub>CC</sub> V	–55 to 25°C	≤ 85°C	≤ 125°C	Unit
V <sub>IH</sub>	Minimum High-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\  I_{out}  \leq 20 \ \mu\text{A} \end{array}$	4.5 5.5	2 2	2 2	2 2	V
V <sub>IL</sub>	Maximum Low–Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\  I_{out}  \leq 20 \ \mu\text{A} \end{array}$	4.5 5.5	0.8 0.8	0.8 0.8	0.8 0.8	V
V <sub>OH</sub>	Minimum High–Level Output Voltage		4.5 5.5	4.4 5.4	4.4 5.4	4.4 5.4	V
		$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out}  \le 6 \text{ mA}$	4.5	3.98	3.84	3.7	
V <sub>OL</sub>	Maximum Low–Level Output Voltage	$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out}  \le 20 \ \mu A$	4.5 5.5	0.1 0.1	0.1 0.1	0.1 0.1	V
		$V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out}  \le 6 \text{ mA}$	4.5	0.26	0.33	0.4	
l <sub>in</sub>	Maximum Input Leakage Current	$V_{in} = V_{CC}$ or GND	5.5	±0.1	±1.0	±1.0	μΑ
I <sub>OZ</sub>	Maximum Three–State Leakage Current	Output in High–Impedance State $V_{in} = V_{IL}$ or $V_{IH}$ ; $V_{out} = V_{CC}$ or GND	5.5	±0.5	±5.0	±10	μΑ
ICC	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC} \text{ or GND } I_{out} = 0 \ \mu A$	5.5	4	40	160	μA
$\Delta I_{CC}$	Additional Quiescent Supply Current	$V_{in}$ = 2.4 V, Any One Input $V_{in}$ = V <sub>CC</sub> or GND, Other Inputs		≥ <b>-55°C</b>	25°C to	o 125°C	
	ounon	$I_{out} = 0 \ \mu A$	5.5	2.9	2	.4	mA

1. Total Supply Current =  $I_{CC} + \Sigma \Delta I_{CC}$ .

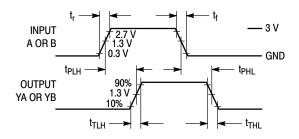
		Guaranteed Limi		Gua		it	
Symbol	Parameter	–55 to 25°C	≤ 85°C	≤ 125°C	Unit		
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, A to YA or B to YB (Figures 2 and 4)	20	25	30	ns		
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Maximum Propagation Delay, Output Enable to YA or YB (Figures 3 and 5)	26	33	39	ns		
t <sub>PZL</sub> , t <sub>PZH</sub>	Maximum Propagation Delay, Output Enable to YA or YB (Figures 3 and 5)	22	28	33	ns		
t <sub>TLH</sub> , t <sub>THL</sub>	Maximum Output Transition Time, Any Output (Figures 2 and 4)	12	15	18	ns		
C <sub>in</sub>	Maximum Input Capacitance	10	10	10	pF		
Cout	Maximum Three–State Output Capacitance (Output in High–Impedance State)	15	15	15	pF		
		Typical @	25°C, V <sub>CC</sub> :	= 5.0 V			
CPD	Power Dissipation Capacitance (Per Enabled Output)*		55		pF		

#### AC ELECTRICAL CHARACTERISTICS (V<sub>CC</sub> = 5.0 V $\pm$ 10%, C<sub>L</sub> = 50 pF, Input t<sub>r</sub> = t<sub>f</sub> = 6 ns)

 C<sub>PD</sub>
 Power Dissipation Capacitance (Per Enabled Output)\*

 \* Used to determine the no-load dynamic power consumption: P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup>f + I<sub>CC</sub> V<sub>CC</sub>.

#### SWITCHING WAVEFORMS





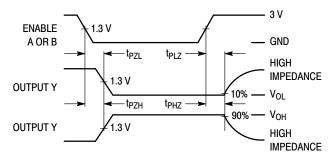
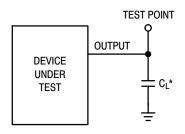


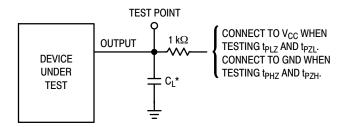
Figure 3.

### **TEST CIRCUITS**



\*Includes all probe and jig capacitance

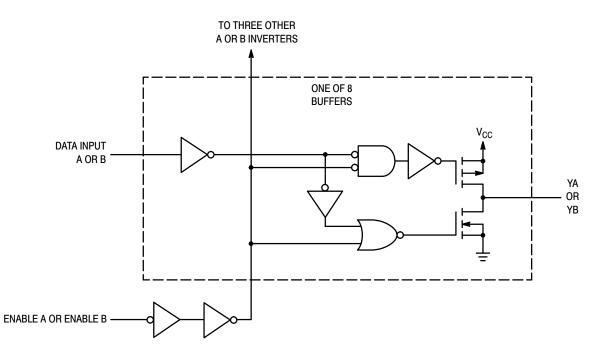




\*Includes all probe and jig capacitance

Figure 5.

#### LOGIC DETAIL



#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC74HCT244ADWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74HCT244ADWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74HCT244ADTR2G	TSSOP-20 (Pb-Free)	2500 / Tape & Reel
NLVHCT244ADTR2G*	TSSOP-20 (Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable.

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